AMENDMENTS TO THE CLAIMS

Please amend Claim 1 as follows. Please cancel Claim 5.

1. (Currently Amended) A flexible circuit, comprising: a substrate having at least one opening; an electrical conductor bonded to a first surface of said substrate;

a first cover layer bonded to said first surface of said substrate and to said electrical conductor; and a second cover layer bonded to a second surface of said substrate and to said first cover layer through said at least one opening, wherein said at least one opening is located in an environmentally stressed region.

- 2. (Original) The flexible circuit according to Claim
- 1, wherein said substrate comprises a polymer.
- 3. (Original) The flexible circuit according to Claim
- 1, wherein said electrical conductor comprises a metallic conductor.
- 4. (Original) The flexible circuit according to Claim
- 1, wherein said first and second cover layers comprise a polymer.
- 5. (Cancelled)

200310509-1 Examiner: Nguyen, Hoa Cao